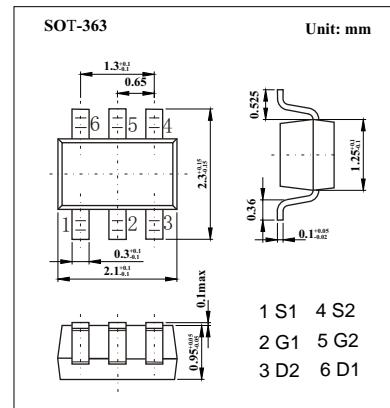
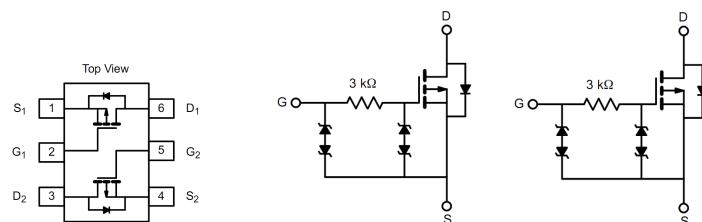


Dual P-Channel MOSFET

KI1917

■ Features

- $V_{DS} = -12V, I_D = -1.0A$
- $R_{DS(on)} = 370m\Omega @ V_{GS} = -4.5V$
- ESD Protected: 3000 V
- Pb-Free Packages are Available
- Lead temperature for soldering: $T_L = 260 \pm 5^\circ C$

■ Absolute Maximum Ratings $T_a = 25^\circ C$

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	V_{DS}	-12	V
Gate-Source Voltage	V_{GS}	± 12	V
Continuous Drain Current $T_J = 150^\circ C$ (<i>Note 1</i>) $T_A = 25^\circ C$ $T_A = 85^\circ C$	I_D	-1.0 -0.73	A
Pulsed Drain Current	I_{DM}	-3	A
Continuous Diode Current (Diode Conduction) (<i>Note 1</i>)	I_S	-0.47	A
Maximum Power Dissipation (<i>Note 1</i>) $T_A = 25^\circ C$ $T_A = 85^\circ C$	P_D	0.57 0.3	W
Maximum Junction-to-Foot(Drain)	$R_{\theta JF}$	100	$^\circ C/W$
Maximum Junction-to-Ambient (<i>Note 1</i>)	$R_{\theta JA}$	220	$^\circ C/W$
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to 150	$^\circ C$

Note: 1. Surface Mounted on 1" x 1" FR4 Board.

KI1917

Electrical Characteristics $T_j = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}} = 0\text{ V}$, $I_D = -100\text{ }\mu\text{A}$	-12			V
Zero Gate Voltage Drain Current	ID_{SS}	$V_{\text{DS}} = -9.6\text{ V}$, $V_{\text{GS}} = 0\text{ V}$			1.0	μA
		$V_{\text{DS}} = -9.6\text{ V}$, $V_{\text{GS}} = 0\text{ V}$, $T_j = 85^\circ\text{C}$			5.0	
Gate Threshold Voltage	$V_{\text{GS(th)}}$	$V_{\text{DS}} = V_{\text{GS}}$, $I_D = -100\text{ }\mu\text{A}$	-0.45			V
Gate-Body Leakage	I_{GSS}	$V_{\text{DS}} = 0\text{ V}$, $V_{\text{GS}} = \pm 12\text{ V}$			± 10	μA
Drain-Source On-State Resistance (Note 2)	$R_{\text{DS(on)}}$	$V_{\text{GS}} = -4.5\text{ V}$, $I_D = -1.0\text{ A}$			370	m
		$V_{\text{GS}} = -2.5\text{ V}$, $I_D = -0.81\text{ A}$			575	
		$V_{\text{GS}} = -1.8\text{ V}$, $I_D = -0.2\text{ A}$			800	
On-State Drain Current (Note 2)	$I_{\text{D(on)}}$	$V_{\text{DS}} = -5\text{ V}$, $V_{\text{GS}} = -4.5\text{ V}$	-2			A
Forward Transconductance (Note 2)	g_{fs}	$V_{\text{DS}} = -10\text{ V}$, $I_D = -1.0\text{ A}$		1.7		S
Total Gate Charge (Note 3)	Q_g	$V_{\text{DS}} = -6\text{ V}$, $V_{\text{GS}} = -4.5\text{ V}$, $I_D = -1.0\text{ A}$		1.3	2.0	nC
Gate-Source Charge (Note 3)	Q_{gs}			0.31		
Gate-Drain Charge (Note 3)	Q_{gd}			0.31		
Turn-On Delay Time (Note 3)	$t_{\text{d(on)}}$	$V_{\text{DS}} = -6\text{ V}$, $R_L = 12\text{ }\Omega$, $I_D = -0.5\text{ A}$ $V_{\text{GS}} = -4.5\text{ V}$, $R_{\text{GEN}} = 6\text{ }\Omega$		0.17	0.26	μs
Rise Time (Note 3)	t_r			0.47	0.71	
Turn-Off Delay Time (Note 3)	$t_{\text{d(off)}}$			0.96	1.4	
Fall Time (Note 3)	t_f			1	1.5	
Diode Forward Voltage (Note 2)	V_{SD}	$I_S = -0.47\text{ A}$, $V_{\text{GS}} = 0\text{ V}$			1.2	V

Notes: 2. Pulse test; pulse width 300 μs , duty cycle 2%.

3. Guaranteed by design, not subject to production testing.